

100

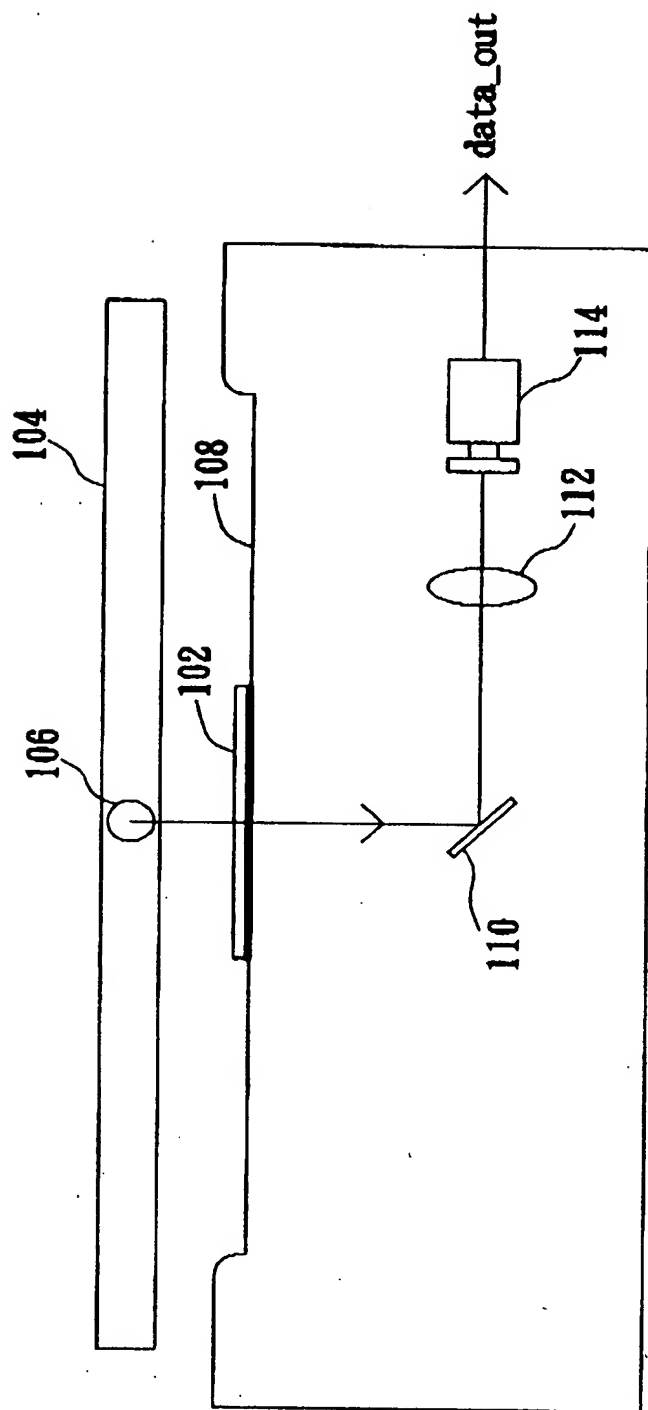


FIG. 1

FIG. 2

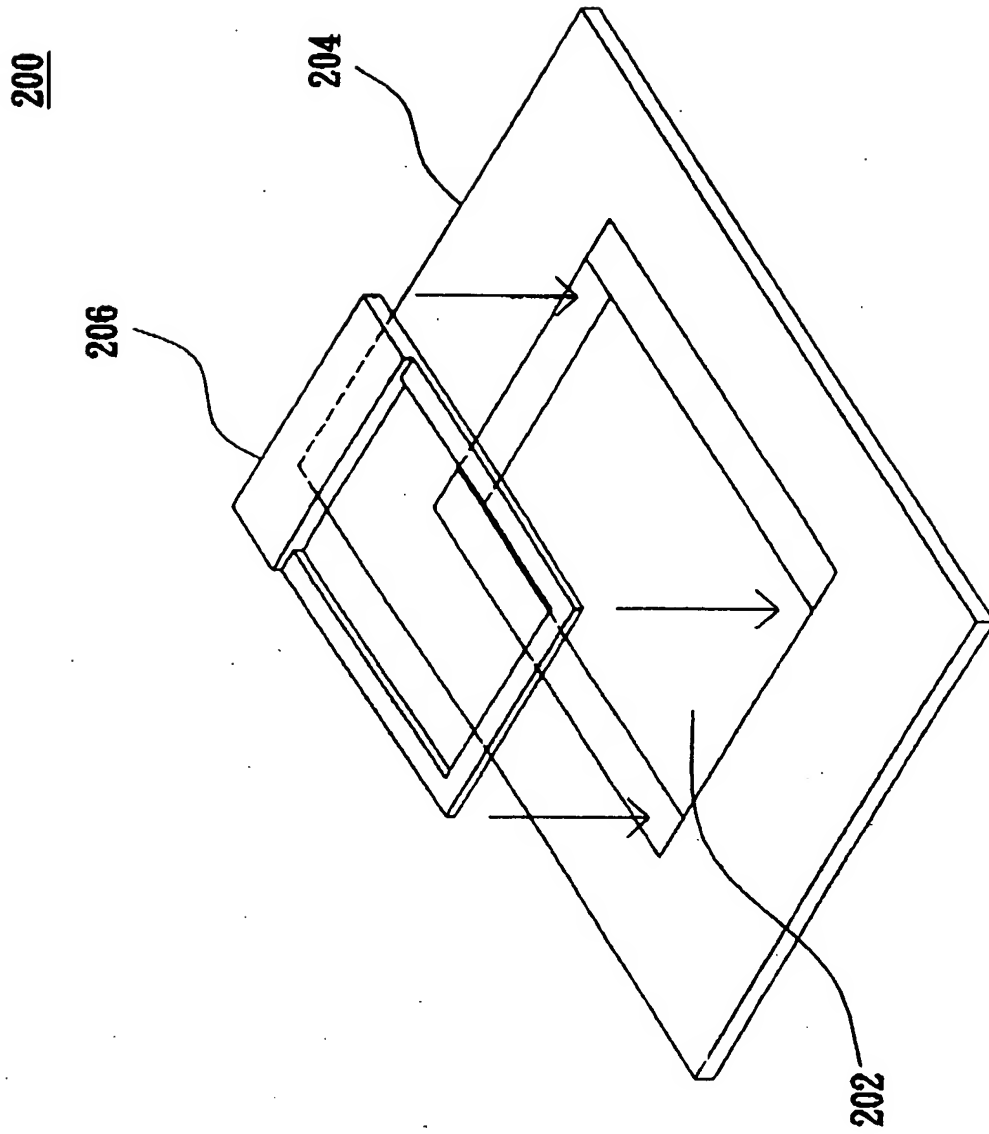


FIG. 2

302

306

304

310

308

303

305

306

FIG. 3A

302

306

304

310

308

307

305

306

FIG. 3B

FIG. 3A and FIG. 3B are schematic diagrams of a device 302 in two different states. In FIG. 3A, the device 302 is in a first state where a component 303 is positioned within a housing 304. The housing 304 has a top edge 308 and a bottom edge 306. A side edge 310 is also shown. In FIG. 3B, the device 302 is in a second state where the component 303 has moved to a different position within the housing 304. The housing 304 has a top edge 308 and a bottom edge 306. A side edge 310 is also shown. The component 303 is shown in a different position within the housing 304 in FIG. 3B compared to FIG. 3A.

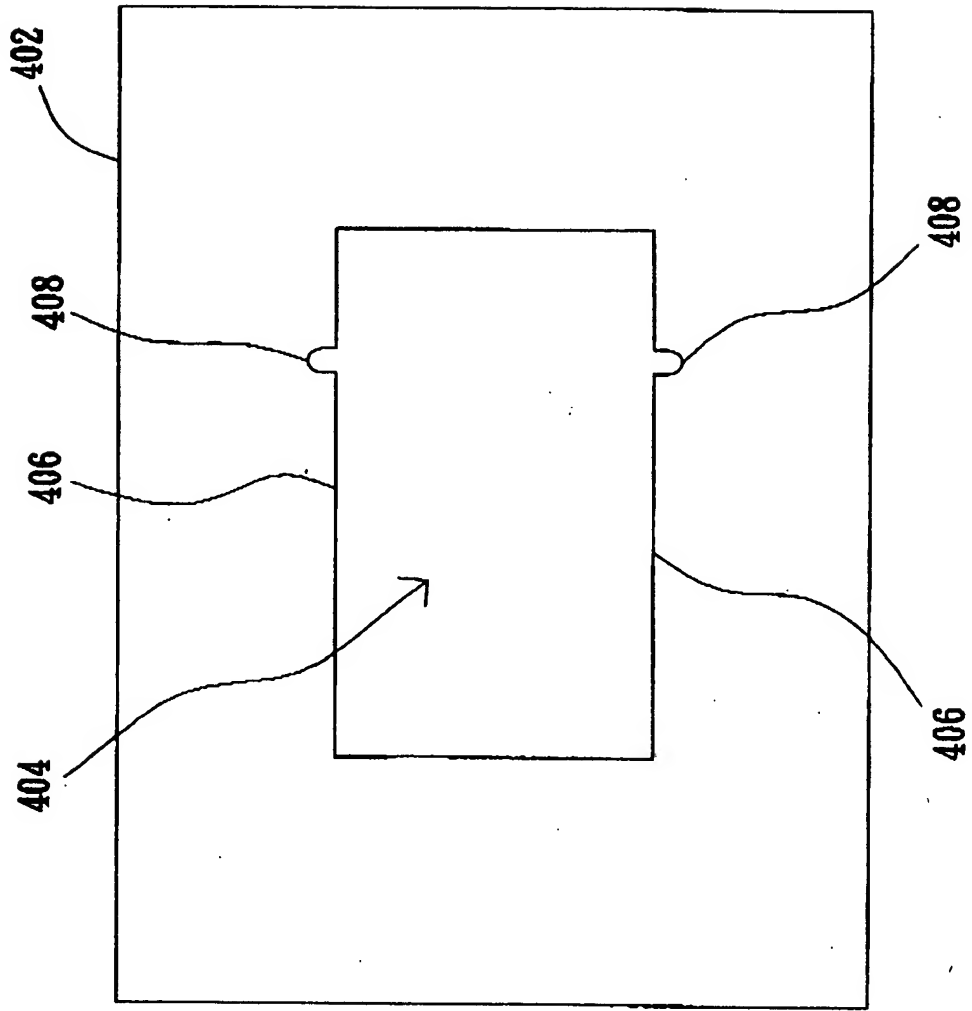


FIG. 4

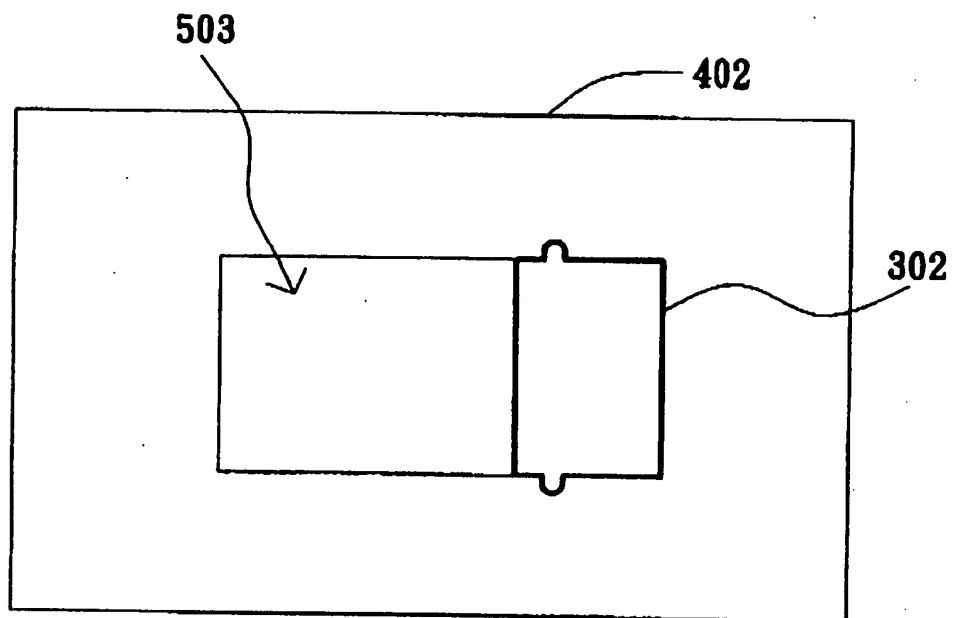


FIG. 5A

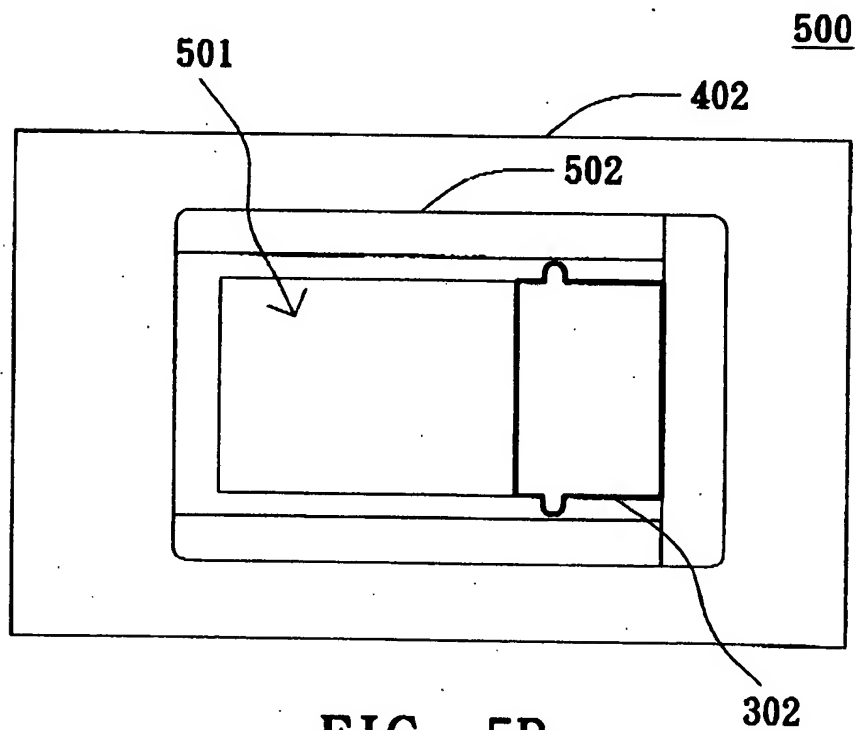


FIG. 5B

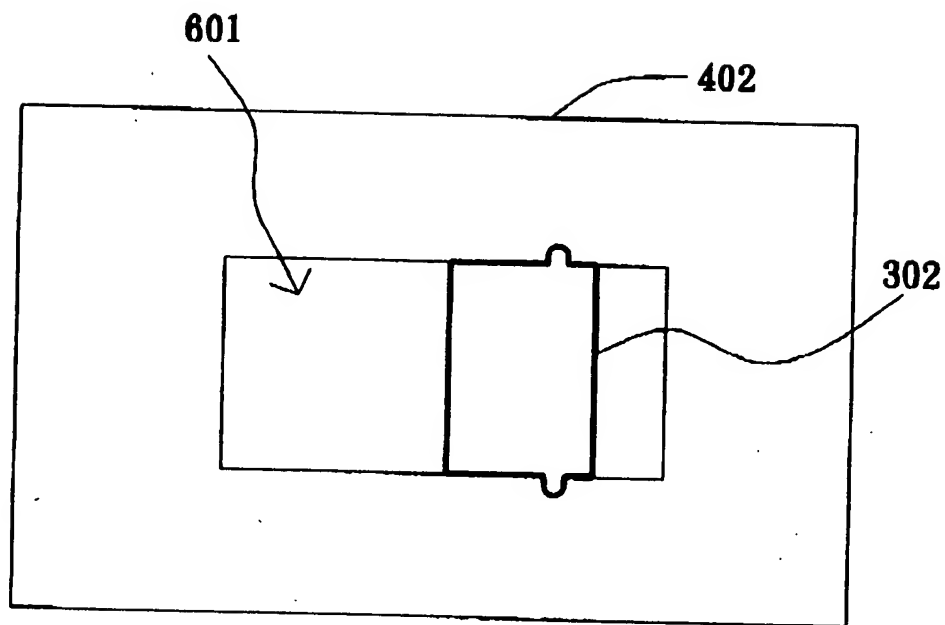


FIG. 6A

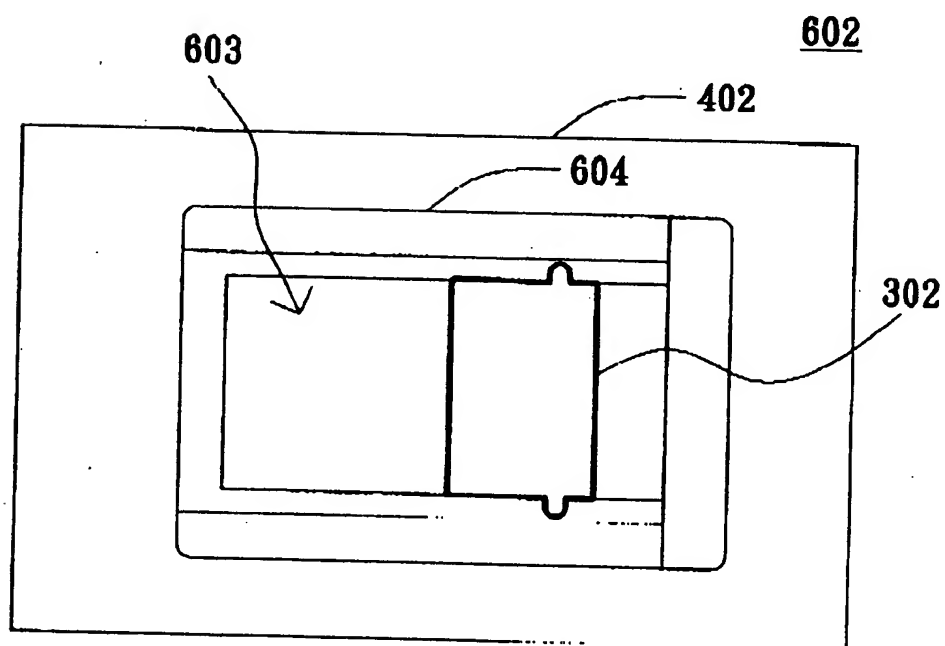


FIG. 6B

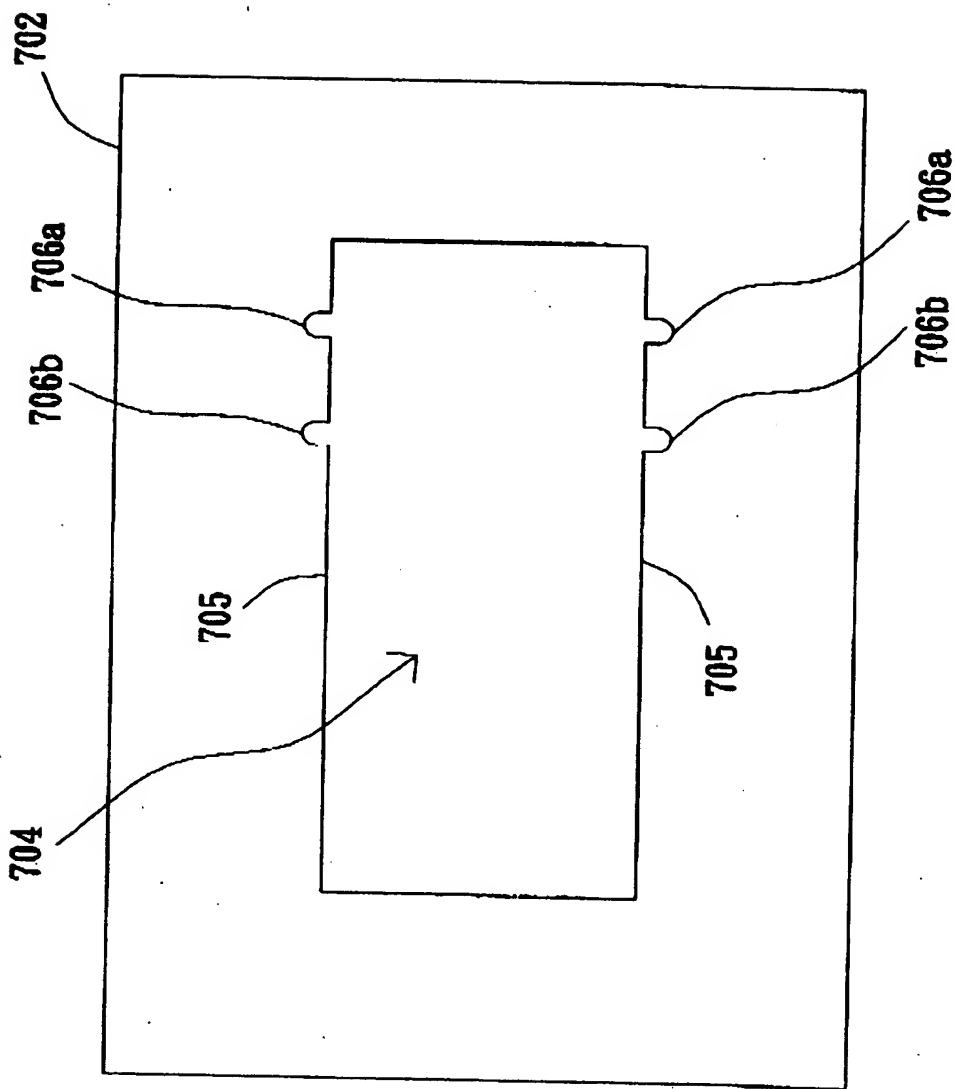


FIG. 7

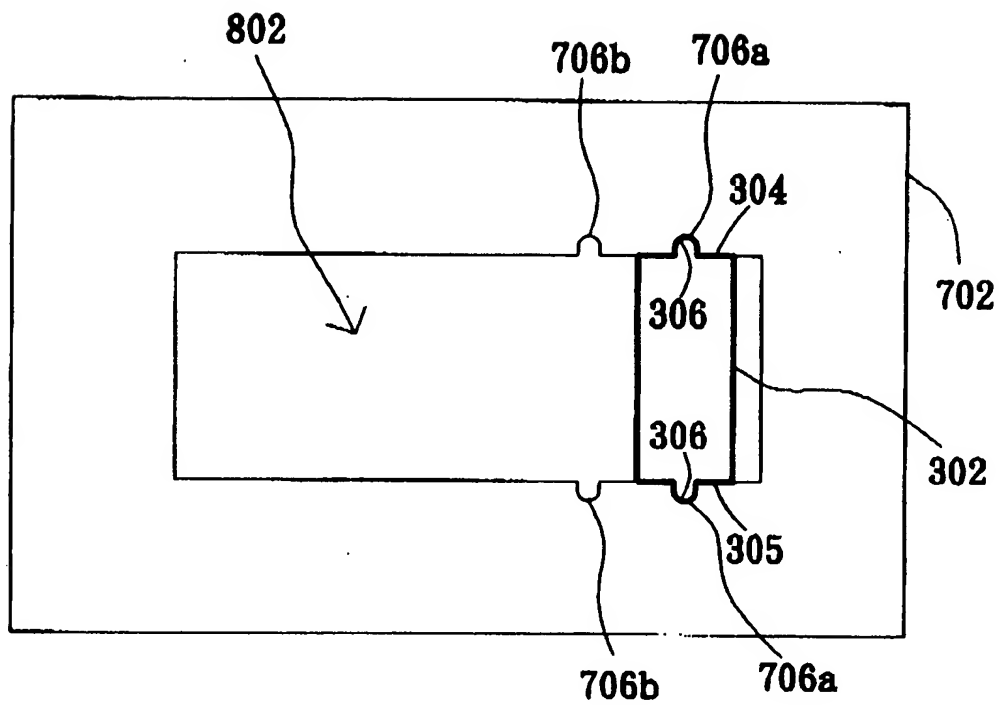


FIG. 8A

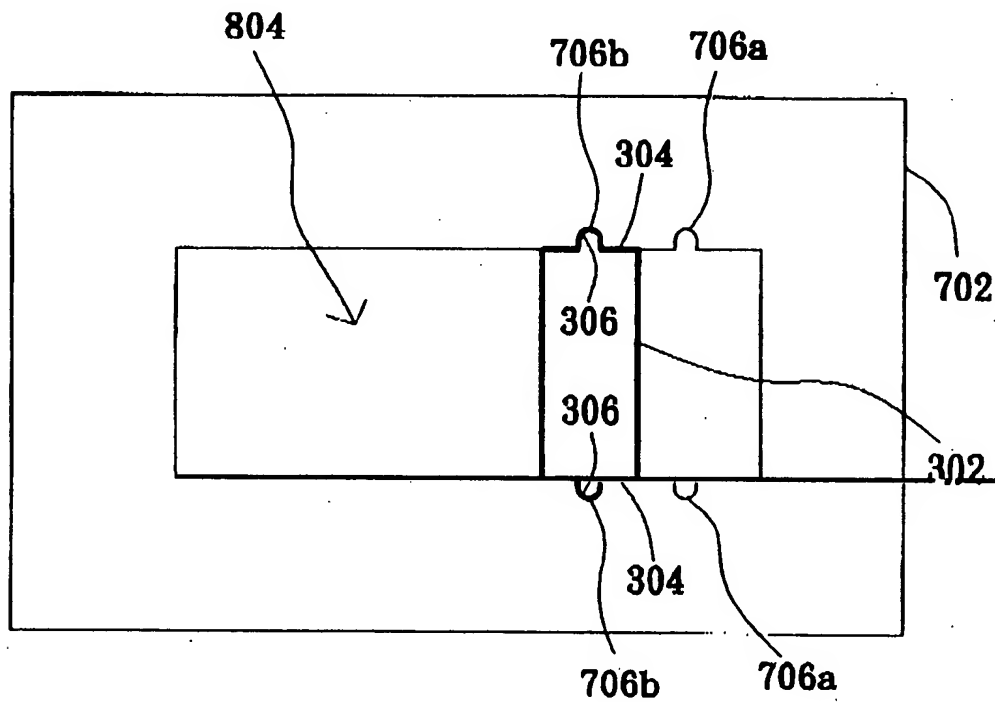


FIG. 8B



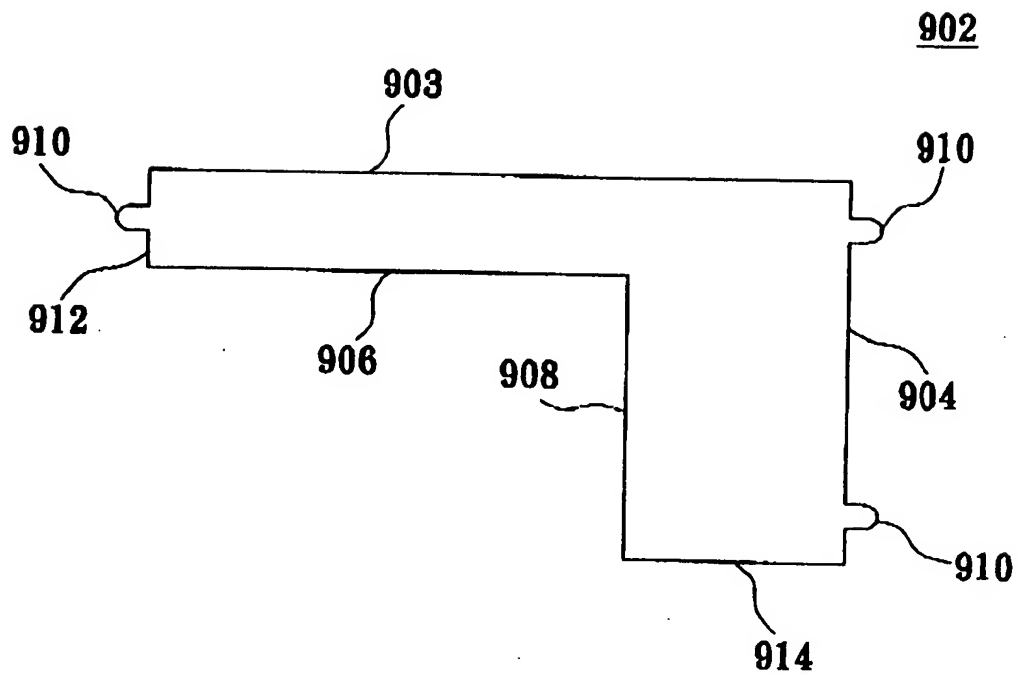


FIG. 9A

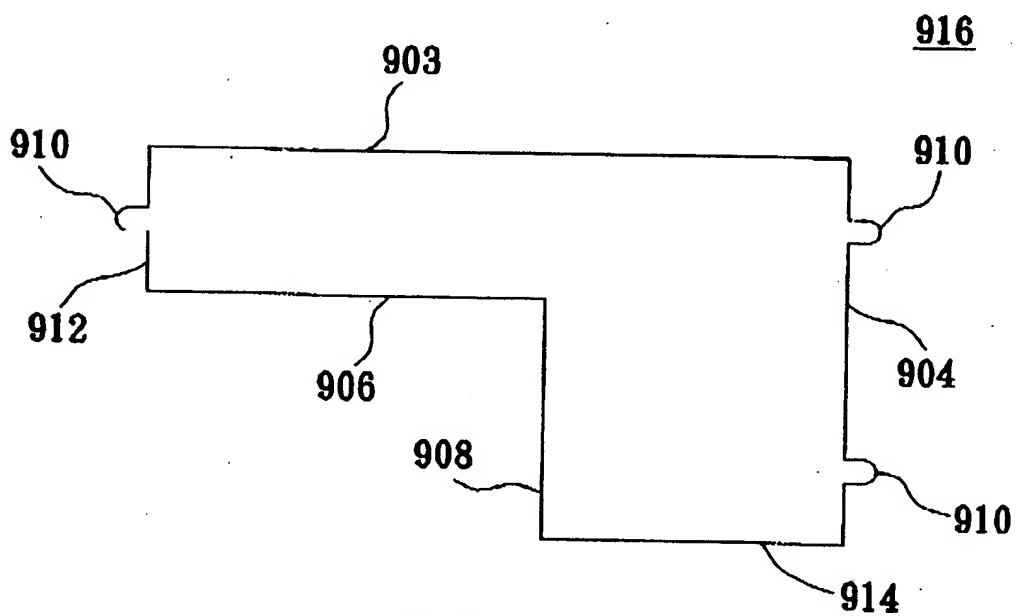


FIG. 9B

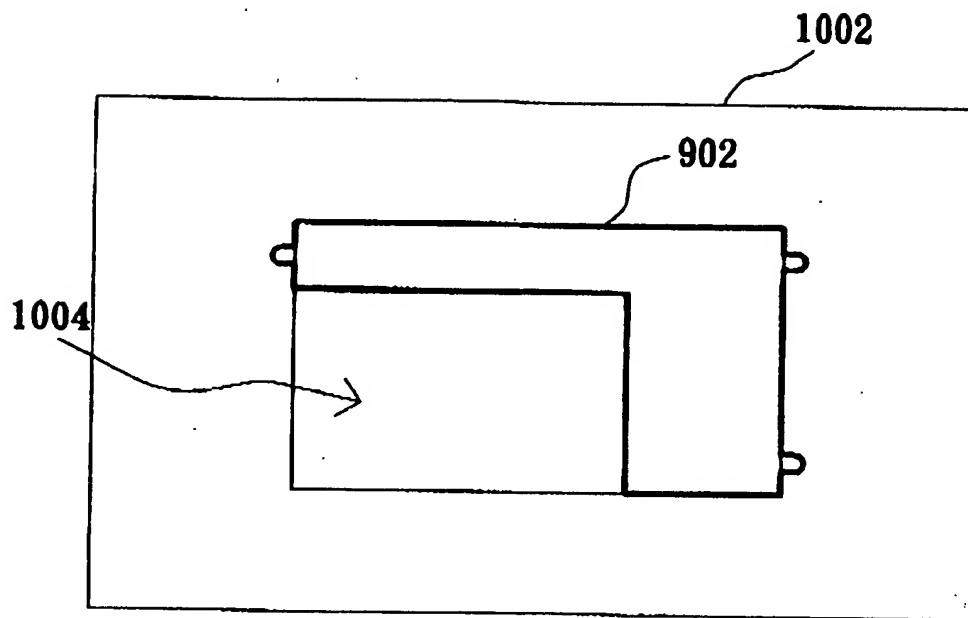


FIG. 10A

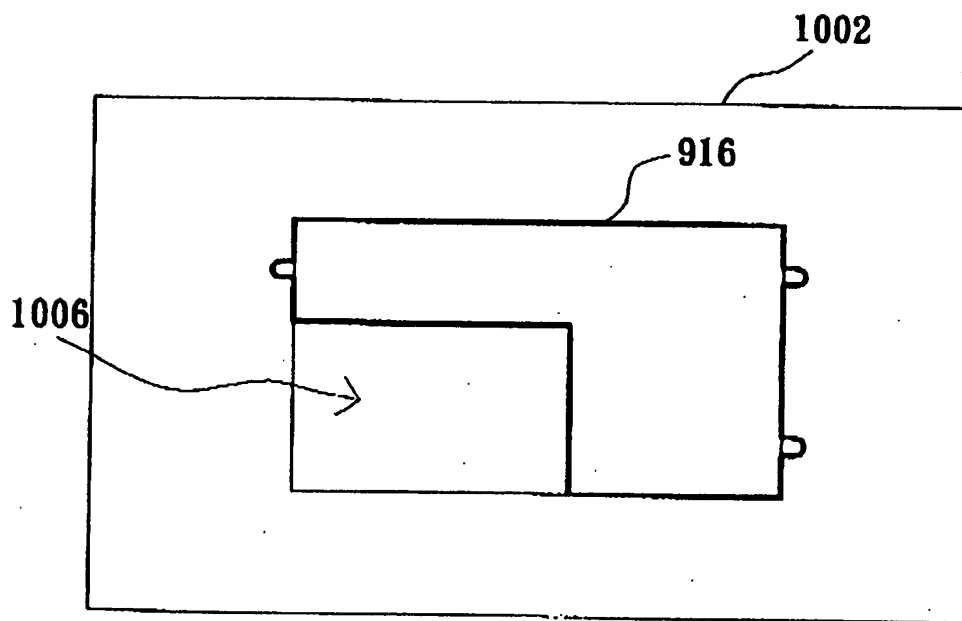


FIG. 10B